Implementation of a Three-Phase Electronic Watt-Hour Meter Using the MSP430F471xx

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ABSTRACT

This application report describes the implementation of a three phase electronic electricity meter using the Texas Instruments MSP430F471xx system-on-chip (SOC) processor. This application report includes the necessary information with regard to metrology software, hardware and calibration procedures for this single chip implementation. Results are included at the end, which show performance of this device for three phase using current transformers as sensors.

1 Introduction

The MSP430F471xx devices belong to the MSP430F4xx family of devices. These devices find its application in energy measurement and have the necessary architecture to support it. The MSP430F471xx devices have a powerful 16 MHz CPU with MSP430CPUx architecture. The analog front-end consists of up to seven analog to digital converters (ADC) based on a 2nd order sigma-delta architecture that supports differential inputs. The sigma-delta ADCs (SD16) that have a resolution of 16-bits can be configured and grouped together for simultaneous sampling of voltages and currents on the same trigger. Each SD16 supports a common mode voltage of up to -1 V and enables all sensors to be referenced to ground. In addition, it also has an integrated gain stage to support gains up to 32 for amplification of low-output sensors. A 32-bit x 32-bit HW multiplier on this chip can be used to further accelerate math intensive operations during energy computation. The SW supports calculation of various parameters for total three phase and for each individual phases. The key parameters calculated during energy measurements are: RMS current and voltage, Active and reactive power, power factor and frequency. The entire operations take about 1/3rd of the processing power and use about a tenth of resources. The application note has complete metrology source code provided as a zip file.

2 Block diagram

Figure 1 depicts the block diagram that shows the high level interface used for a three-phase energy meter application. A three-phase four wire star connection to the mains is shown in this case. Current transformers (CT) are connected to each of the current channels and a simple voltage divider is used for corresponding voltages. Each CT has an associated burden resistor that has to be connected at all times to protect the measuring device. The choice of the CT and the burden resistor is done based on the manufacturer and current range required for energy measurements. The choice of voltage divider resistors for each voltage channel is selected to ensure the mains voltage is divided down to adhere to the normal input ranges that are valid for the MSP430 SD16. Refer to the 4xx user’s guide and specific datasheet for these numbers.
Figure 1: 3-phase 4-wire star connection using the MSP430F47197
3 Hardware implementation

This section describes various pieces that constitute the HW for the working of an energy meter using the MSP430F471xx.

3.1 Power supply

The MSP430 family of devices is ultra low-power microcontrollers from Texas Instruments. These devices support a number of low-power modes, in addition, boast of low-power consumption during active mode when the CPU and other peripherals are active. The low-power feature of this device family allows design of the power supply to be very extremely simple and cheap. The power supply allows the operation of the energy meter powered directly from the mains. The next sub-sections discuss the various power supply options that are available to users to support their design.

3.1.1 Resistor Capacitor (RC) power supply

Figure 2 shows a simple capacitor power supply for a single output voltage of 3.3V directly from the mains.

Figure 2: A simple capacitive power supply for the MSP430 energy meter

Appropriate values of resistors (R4-R6) and capacitors (C1-C3) are chosen based on the required output current drive of the power supply. Voltage from mains is directly fed to a RC based circuit followed by a rectification circuitry to provide a DC voltage for the operation of the MSP430. This DC voltage is regulated to 3.3V for full speed operation of the MSP430. For the circuit above, the approximate drive provided by each phase is about 12mA. The design equations for the power supply are given in the application note from Texas Instruments; SLAA024, section 3.8.3.2. The above configuration allows for all three phases to provide the required current drive, which would then be three times the drive available from each phase. If a need for additional drive is required, either an NPN output buffer or a transformer based power supply maybe used.
3.1.2 Transformer based power supply

For instances when a higher current drive is required, especially when RF transceivers are used, the simple capacitive power supply does not provide enough drive. Hence, a transformer based power supply is required. Voltage from the mains is brought down using a step-down transformer followed by a rectification circuitry. For this condition, a transformer is not needed at all three phases. Appropriate transformers must be selected to provide the drive required by the entire board. Figure 3 shows an example of the transformer based circuitry that can be used for the MSP430F47197 based energy meter.

![Figure 3: A transformer based power supply for the MSP430 energy meter](image)

3.2 Analog inputs

The MSP430 analog front end that consists of the SD16 ADC is differential and requires that the input voltages at the pins do not exceed +/- 500mV (gain=1). In order to meet this specification the current and voltage inputs need to be divided down. In addition the SD16 allows a maximum negative voltage of -1V, hence AC signals from mains can be directly interfaced without the need for level shifters. This sub-section describes the analog front end used for voltage and current channels.

3.2.1 Voltage inputs

The voltage from the mains is usually 230 V or 110V and needs to be brought down to a range of 500mV. The analog front end for voltage consists of spike protection varistors followed by a simple voltage divider and a RC low-pass filter that acts like an anti-alias filter.
Figure 4: Analog front end for voltage inputs

Figure 4 shows the analog front end for the voltage inputs for a mains voltage of 230V. The voltage is brought down to approximately 350mV RMS, which is 495mV peak and fed to the positive input, adhering to the MSP430 SD16 analog limits. A common mode voltage of zero can be connected to the negative input of the SD16. In addition, the SD16 has an internal reference voltage of 1.2V that can be used externally and also as a common mode voltage if needed.

It is important to note that the anti-alias resistors on the positive and negative sides are different because, the input impedance to the positive terminal is much higher and therefore a lower value resistor is used for the anti-alias filter. If this is not maintained, a relatively large phase shift of several degrees would result.

3.2.2 Current inputs

The analog front-end for current inputs is a little different from the analog front end for the voltage inputs. Figure 4 shows the analog front end used for current channel I1 following the CT used.

Figure 5: Analog front end for current inputs
Resistor R27 is the burden resistor that would be selected based on the current range used and the turns-ratio specification of the CT. The value of the burden resistor for this design is around 5.1 Ohms. The anti-aliasing circuitry consisting of R26, R28, C20 and C22 follows the burden resistor. The input signal to the converter is a fully differential input with a voltage swing of +/-500mV maximum with gain of the converter set to 1. Similar to the voltage channels, the common mode voltage is selectable to either analog ground (AGND) or internal reference (VREF).

4 Software Implementation

The software for the implementation of 3-phase metrology is discussed in this section. The first subsection discusses the setup of various peripherals of the MSP430. Subsequently, the entire metrology software is described as two major processes; foreground process and background process.

4.1 Peripherals setup

The major peripherals are the 16-bit sigma delta (SD16) ADC, clock system, LCD, basic timer (BT), watchdog timer (WDT).

4.1.1 SD16 setup

As mentioned before, the F47197 has up to seven independent sigma delta data converters. For a three phase system at least six SD16s are necessary to independently measure three voltages and currents. The code accompanying this application note will address the metrology for a 3-phase system with limited discussion to anti-tampering. Hence all seven SD16s are configured. Power or energy measurement relies on the product of instantaneous voltage and current samples. To ensure the reliability of this product, there should not be any difference or delay in time during their sampling. The MSP430 SD16s allow several features to ensure easy and accurate sampling of voltage and current samples for all six channels. To ensure the reliability of this product, there should not be any difference or delay in time during their sampling. The MSP430 SD16s allow several features to ensure easy and accurate sampling of voltage and current samples for all six channels. The group feature grouping of SD16s to allow simultaneous sampling of all on a single trigger. More is discussed under background process. The clock to the SD16 (fM) is derived from the FLL that is locked to the 32.768 KHz external crystal (ACLK). The sampling frequency is defined as \( f_s = \frac{f_M}{\text{OSR}} \), the OSR is chosen to be 256 and the modulation frequency \( f_M \), is chosen as 1.048576 MHz, resulting in a sampling frequency of 4.096 Ksps. The SD16s are configured to generate regular interrupts every sampling instant.

The following are the SD16 channels associations

A0.0+ and A0.0- → Voltage V1
A1.0+ and A1.0- → Voltage V2
A2.0+ and A2.0- → Voltage V3
A3.0+ and A3.0- → Current I1
A4.0+ and A4.0- → Current I2
A5.0+ and A5.0- → Current I3
Optional neutral channel can be processed via channel A6.0+ and A6.0-.

4.1.2 **Clock system**

The MSP430 supports an external low-frequency crystal (ACLK) of 32.768 KHz, the on-chip FLL locks to this crystal. The FLL sources the CPU clock (MCLK) and SMCLK which is configured to an integer multiple of ACLK. For the current application 12 MHz and 16 MHz frequency options have been provided.

4.1.3 **Basic Timer (BT)**

The BT is configured to give precise 1 second interrupts for Real-time clock (RTC) functionality. The clock to the BT is ACLK, which is the external 32.768 KHz crystal.

4.1.4 **LCD controller**

The LCD controller on the F47197 can support up to 4-mux displays and 160 segments. It is also equipped with an internal charge pump that can be used for good contrast. In the current design, the LCD controller is configured to work in 4-mux mode using the entire 160 segments. The refresh rate is set to ACLK/128, which is 256 Hz.

4.1.5 **Supply Voltage Supervisor (SVS)**

The SVS module is a key peripheral in the MSP430 providing supply voltage monitoring. Figure 6 shows the CPU frequency versus voltage requirement for reliable operation for the F471xx devices. The built in hardware SVS is turned ON to ensure that the MCU is in a known state at all times.

![Figure 6: System (CPU) frequency versus voltage requirement](image-url)
The F47197 CPU can operate up to 16 MHz and this maximum speed can be achieved only for supply voltage ($V_{cc}$) $\geq 3.3$ V. In order to ensure reliable operation of the CPU at any specified frequency, the minimum $V_{cc}$ has to be met from Figure 6. The SVS module can be configured to perform this check and must be the first step in SW before changing the FLL to operate at this higher frequency. The SVS can continue to monitor the $V_{cc}$ and can be made to generate a system reset whenever the voltage dips below the minimum allowed level for that operating speed. In addition the $V_{cc}$ for the MSP430 derived from the mains can also be connected to the input of the comparator. This will pre-warn the system when there is a mains black-out to go into ultra-low-power RTC mode.

4.2 The Foreground Process

The foreground process includes the initial setup of the MSP430 HW and SW immediately after a device RESET. Figure 7 shows the flowchart for this process.
The initialization routines involve the setup of the analog to digital converter (SD16), Clock system, LCD controller, general purpose input/output (port) pins, timer and the Universal Serial Communication Interface (USCI) for UART functionality. A check is made if the main power is OFF and the device goes into LPM0. During normal operation, the background process notifies the foreground process through a status flag every time a frame of data is available for processing. This data frame consists of accumulation of energy for 1 second. This is equivalent to accumulation of 50 or 60 cycles of data samples synchronized to the incoming voltage signal. In addition, a sample counter keeps track of how many samples have been accumulated over the frame period. This count can vary as the software synchronizes with the incoming mains frequency. The data samples set consist of processed current, voltage, active and reactive energy. All values are accumulated in separate 48-bit registers to further process and obtain the RMS and mean values.

4.2.1 Formulae

This section briefly describes the formulae used for the voltage, current and energy calculations.

4.2.1.1 Voltage and Current

As discussed in the previous sections simultaneous voltage and current samples are obtained from six independent SD16 converters at a sampling rate of 4096 Hz. Track of the number of samples that are present in 1 second is kept and used to obtain the RMS values for voltage and current for each phase.

\[
V_{RMS} = K_v \left( \frac{\sum_{n=1}^{Sample\ count} v_{ph}^2(n)}{Sample\ count} \right)^{\frac{1}{2}}
\]

\[
I_{RMS} = K_i \left( \frac{\sum_{n=1}^{Sample\ count} i_{ph}^2(n)}{Sample\ count} \right)^{\frac{1}{2}}
\]

\( ph \) = Phase that takes the value 1, 2 or 3.

\( v_{ph}(n) \) = Voltage sample at a sample instant ‘n’

\( i_{ph}(n) \) = Current sample at a sample instant ‘n’

\( Sample\ count \) = Number of samples in 1 second

\( K_v \) = Scaling factor for voltage

\( K_i \) = Scaling factor for current
4.2.2 Power and energy

Power and energy are calculated for a frame’s worth of active and reactive energy samples. These samples are phase corrected and passed on to the foreground process that uses the number of samples (sample count) and use the formulae listed below to calculate total active and reactive powers.

\[
P_{\text{Act, Total}} = \sum_{\text{ph}=1}^{3} K_p(\text{ph}) \times \frac{\sum_{n=1}^{\text{Sample count}} v_{\text{ph}}(n) \times i_{\text{ph}}(n)}{\text{Sample count}}
\]

\[
P_{\text{React, Total}} = \sum_{\text{ph}=1}^{3} K_p(\text{ph}) \times \frac{\sum_{n=1}^{\text{Sample count}} v_{90, \text{ph}}(n) \times i_{\text{ph}}(n)}{\text{Sample count}}
\]

\[v_{90, \text{ph}}(n) = \text{Voltage sample at a sample instant ‘}n\text{’ shifted by 90 degrees}\]

\[K_p(\text{ph}) = \text{Scaling factor for power}\]

The consumed energy is then calculated based on the active power value for each frame in a similar way as the energy pulses are generated in the background process except that

\[E_{\text{Act, Total}} = P_{\text{Act, Total}} \times \text{Sample count}\]

For reactive energy we use the 90 degree phase shift approach for two reasons:

1. This allows us to measure the reactive power accurately down to very small currents.
2. This conforms to international specified measurement method.

Since the frequency of the mains varies, it is important to first measure the mains frequency accurately and then phase shift the voltage samples accordingly. This is discussed under Frequency measurement and cycle tracking in the following section.

The phase shift consists of an integer part and a fractional part, the integer part is realized by providing an N samples delay. The fractional part is realized by a fractional delay filter (refer to: Phase compensation).

4.2.3 Display

An additional display routine is called from the foreground process. This scrolls through in 2 second delays, displaying a number of values, \(V_{\text{RMS}}\), \(I_{\text{RMS}}\), power, frequency, power factor, temperature, real-time clock etc.
4.3 The Background process

The background process uses the SD16 interrupt as a trigger to collect voltage and current samples for each phase (six values in total). These samples are further processed and accumulated in dedicated 48-bit registers. The background function deals mainly with timing critical events in software. Once sufficient samples (1 second worth) have been accumulated then the foreground function is triggered to calculate the final values of $V_{\text{RMS}}$, $I_{\text{RMS}}$, power and energy. The background process is also wholly responsible for energy proportional pulses, frequency and power factor calculation for each phase. Figure 8 shows the flow diagram of the background process.

Figure 8: Background process
The following sections discuss the various elements of electricity measurement in the background process.

4.3.1 *Sigma Delta Converter interrupt*

The SD16 converter is self triggering at a sampling frequency of 4096 samples/sec. The seven independent converters are setup to sample in group mode. Each sample interval of approximately 250μs would return three pairs of current (I) and voltage (V) samples plus the neutral sample if needed. Figure 9 shows the SD16 signal flow with function blocks for one of the phases. However, all three phases have similar functionality.

![Diagram of SD16 samples signal flow]

**Figure 9: SD16 samples signal flow**

4.3.2 *Voltage and Current signals*

The Sigma Delta Converter has a fully differential input and therefore no added DC offset is needed to precondition a signal which is the case with most single ended converters.

The output of the Sigma Delta is a 16-bit signed integer. Any stray DC offset value is removed independently for V and I by subtracting a long term DC tracking filter’s output from each SD16 sample. This long term DC tracking filter is synchronized to the mains cycle to yield a highly stable output.

The resulting instantaneous voltage and current samples are used to generate the following information:

- Accumulated Squared voltage values of voltage and current for \( V_{\text{RMS}} \) and \( I_{\text{RMS}} \) calculations.
- Accumulated energy samples to calculate Active energy.
Accumulated energy samples with current and 90 degree phase shifted voltage to calculate Reactive energy.

These accumulated values are processed by the foreground process.

### 4.3.3 Phase Compensation

The Current Transformer (CT) when used as a sensor and the input circuit's passive components together introduces an additional phase shift between the current and voltage signal that needs compensation. The SD16 converter has built in hardware delay that can applied to individual samples when grouped. This can be used to provide the phase compensation required. This value is obtained during calibration and loaded on to the respective PRELOAD register for each converter. Figure 10 shows the application of PRELOAD

![Phase compensation using PRELOAD register](image)

The fractional delay resolution is a function of input frequency \( (f_{in}) \), OSR and the sampling frequency \( (f_s) \).

\[
\text{Delay resolution}_{\text{Deg}} = \frac{360^\circ \times f_{in}}{\text{OSR} \times f_s} = \frac{360^\circ \times f_{in}}{f_m}
\]

In the current application for input frequency of 60Hz, OSR of 256 and sampling frequency of 4096, the resolution for every bit in the preload register is about 0.02 degrees with a maximum of 5.25 degrees (maximum of 255 steps). Since the sampling of the 7 channels are group triggered. An often method used is to apply 128 steps of delay to all channels and then increasing or decreasing from this base value. This allows +/- delay timing to compensate for phase lead or lag. This puts the practical limit in the current design to +/- 2.62 degrees. When using CTs that provide a larger phase shift than this maximum, an entire sample delay along with fractional delay must be provided. This phase compensation can also be modified on the fly to accommodate temperature drifts in CTs.

### 4.3.4 Frequency measurement and cycle tracking

The instantaneous I and V signals for each phase are accumulated in 48 bit registers. A cycle tracking counter and sample counter keep track of the number of samples accumulated. When approximately one second’s worth of samples have been accumulated, the background process stores these 48-bit registers and notifies the foreground process to produce the average results like RMS and power values. We use cycle boundaries to trigger the foreground averaging process since it gives very stable results.
For frequency measurements, we do a straight line interpolation between the zero crossing voltage samples. Figure 11 depicts the samples near a zero cross and the process of linear interpolation.

Since noise spikes can also cause errors, we use the rate of change check to filter out the possible erroneous signals and make sure that the two points are interpolated from are genuine zero crossing points. For example, if you have two negative samples, a noise spike can make one of them positive and therefore making the negative and positive pair looks as if there is a zero crossing.

The resultant cycle to cycle timing goes through a weak low pass filter to further smooth out cycle to cycle variations. This results in a stable and accurate frequency measurement tolerant of noise.

4.3.5 LED Pulse generation

In electricity meters, the energy consumed is normally measured in fraction of Kilo Watt Hour (KWh) pulses. This information can be used to accurately calibrate any meter or to report measurement during normal operation. In order to serve both these tasks efficiently the microcontroller has to accurately generate and record the number of these pulses. It is a general requirement to generate these pulses with relatively little jitter. Although, time jitters are not an indication of bad accuracy, as long as the jitter is averaged out it would give a negative indication on the overall accuracy of the meter.

We use the average power to generate the energy pulses. The average power (calculated by the foreground process) is accumulated every SD16 interrupt. This is equivalent to converting it to energy. Once the accumulated energy crosses a threshold, a pulse is generated. The amount of energy above this threshold is kept and new energy amount is added on top of it in the next interrupt cycle. Since the average power tends to be a stable value, this way of generating energy pulses are very steady and free of jitter.
The threshold determines the energy “tick” specified by the power company and is a constant. For example this can be in KWh. In most meters, the pulses per KWh decide this energy tick. For example in this application the number of pulses generated per KWh is set to 1600 for active and reactive energies. The energy “tick” in this case is 1KWh/1600. In addition to total three phase energy pulses, pulses for individual phases are also generated and indicated via LEDs on the board. Port pins are toggled for the pulses with control over the pulse width for each pulse. Figure 12 shows the flow diagram for pulse generation.

![Figure 12: Pulse generation for energy indication](image)

The average power is in units of 0.01W and 1KWh threshold is defined as

\[
1\text{KWh threshold} = \frac{1}{0.01} \times 1\text{KW} \times (\text{Number of interrupts/sec}) \times (\text{number of seconds in 1 Hr})
\]

\[
= 100000 \times 4096 \times 3600 = 0x15752A00000
\]
4.4 Energy meter configuration

Include files are used to initialize and configure the energy meter to perform several metrology functions. In this section we list some of the options available that are user configurable. The file that needs modification is the “emeter-3ph-neutral-47197.h” present in the parent directory “emeter-ng”. It includes macro definitions that are used during the normal operation of the meter.

1. SERIAL_CALIBRATION_SUPPORT: This macro when defined will allow the meter to be calibrated using the GUI provided and RS-232 interface to the PC.

2. MAINS_FREQUENCY_SUPPORT: The macro when defined will configure the meter to measure the frequency of the mains.

3. MAINS_NOMINAL_FREQUENCY: The macro defines the default mains frequency, which will be as a starting point for dynamic phase correction for non-linear CTs, or other sensors for which the phase changes with the current.

4. TOTAL_ENERGY_PULSES_PER_KW_HOUR: This macro defined the total number of pulses per 1KWh of energy. In this application it is defined to 1600. It is important to note that this value is not a standard, but widely used by many meter manufacturers. There could be a practical limit set on this number due to the reference meter’s ability to accept fast pulses (due to large currents). This number is true for total three phase energy only.

5. PHASE_ENERGY_PULSES_PER_KW_HOUR: This macro defined the total number of pulses per 1KWh of energy at each phase. In this application it is defined to 1600 if pulses generation for each individual phase has been enabled.

6. INHIBIT_NEGATIVE_PHASE_POWER_ACCUMULATION: This macro will prevent negative energy to be accumulated at individual phases. Negative energy could be a result of reversed connection at the voltage or current but not both at any of the phases.

7. INHIBIT_NEGATIVE_TOTAL_POWER_ACCUMULATION: This macro will prevent negative energy to be accumulated for the three phases combined. Negative energy could be a result of reversed connection at the voltage or current but not both at any of the phases.

8. ENERGY_PULSE_DURATION: This macro defines the duration of the LED ON time for an energy pulse. This is measured in ADC samples (i.e. increments 1/4096 s). The maximum allowed is 255, giving a pulse of about 62.5 ms and 163 gives a 40 ms pulse. This duration might be too large with adjacent pulses overlapping when very high currents are measured. It is recommended that this value be changed to a smaller number such as 80, if overlap is seen at the pulse outputs.

9. RESIDUAL_POWER_CUTOFF: Tiny power levels should not record at all, as they may just be rounding errors, noise, or the consumption of the meter itself. This value is the cutoff level, in 0.01 Watt increments. In this application it is set to 250, resulting in a start-energy of about 2.5 Watts.

10. NEUTRAL_MONITOR_SUPPORT: This macro enables the support for neutral monitoring. The 7th SD16 is used for this purpose.

11. LIMP_MODE_SUPPORT: This macro is used to enable the meter to operate under LIMP mode.
12. MAINS_NOMINAL_VOLTAGE: This macro defines the nominal voltage to be used during LIMP mode. Nominal voltage is used for power calculations during this mode.

13. VRMS_SUPPORT: This macro is used to configure the meter to calculate $V_{\text{RMS}}$ from the voltage samples.

14. IRMS_SUPPORT: This macro is used to configure the meter to calculate $I_{\text{RMS}}$ from the current samples.

15. REACTIVE_POWER_SUPPORT: This macro is used to configure the meter to calculate the reactive power from the voltage and current samples.

16. REACTIVE_POWER_BY_QUADRATURE_SUPPORT: This macro is used to configure the meter to calculate the reactive power from the delayed voltage samples by 90 degrees and current samples instead of using the power triangle method.

17. APPARENT_POWER_SUPPORT: This macro is used to configure the meter to calculate the apparent power.

18. POWER_FACTOR_SUPPORT: This macro is used to configure the meter to calculate the power factor for both lead and lag. A frequency independent method, based on the ratio of scalar dot products, is used.

19. TOTAL_ACTIVE_ENERGY_SUPPORT: This macro is used to configure the meter to calculate the total 3-phase active energy consumption.

20. PER_PHASE_ACTIVE_ENERGY_SUPPORT: This macro is used to configure the meter to calculate the active energy consumption for individual phases in addition to the total 3-phase active energy.

21. TOTAL_REACTIVE_ENERGY_SUPPORT: This macro is used to configure the meter to calculate the total 3-phase reactive energy consumption.

22. PER_PHASE_REACTIVE_ENERGY_SUPPORT: This macro is used to configure the meter to calculate the reactive energy consumption for individual phases in addition to the total 3-phase reactive energy.

23. TEMPERATURE_SUPPORT: This switch enables use of the MSP430's internal temperature sensor to measure the meter's temperature.

24. MAGNETIC_INTERFERENCE_CURRENT: This macro defines the current to be used during anti-tampering. When magnetic tampering is detected, the output of CTs is completely unreliable. The meter can only assume there is a very high load at unity power factor, and charge accordingly. In this application the units for this current is mA and is set to 60000 (60A) to be used for calculations.

25. RTC_SUPPORT: This macro is used to configure the meter to support a real-time clock. A software RTC is implemented for this purpose.

26. CORRECTED_RTC_SUPPORT: This macro enables temperature compensation for the real-time clock. It performs basic error compensation for the MSP430's 32 kHz crystal oscillator to enable a higher quality RTC source, even using low accuracy (Eg: 20ppm) crystals.
27. CURRENT_PHASE_GAIN: This macro defines the gain of the SD16’s internal programmable gain amplifier (PGA) for all the three currents. In this application it is set to 1.

28. CURRENT_NEUTRAL_GAIN: This macro defines the gain of the SD16’s internal PGA for neutral current monitoring. In this application it is set to 16.

29. VOLTAGE_GAIN: This macro defines the gain of the SD16’s internal programmable gain amplifier (PGA) for all the three voltages. In this application it is set to 1.

30. PHASE_REVERSED_DETECTION_SUPPORT: This macro configures the meter to detect reversed power condition.

31. PHASE_REVERSED_IS_TAMPERING: This macro configures the meter to treat phase reversed connections as tampering.

32. DEFAULT_V_RMS_SCALE_FACTOR_A: This macro holds the scaling factor for voltage at phase 1, this can be set to a value that is in fairly acceptable range and will be fine tuned during calibration.

33. DEFAULT_V_RMS_SCALE_FACTOR_B: This macro holds the scaling factor for voltage at phase 2, this can be set to a value that is in fairly acceptable range and will be fine tuned during calibration.

34. DEFAULT_V_RMS_SCALE_FACTOR_C: This macro holds the scaling factor for voltage at phase 3, this can be set to a value that is in fairly acceptable range and will be fine tuned during calibration.

35. DEFAULT_I_RMS_SCALE_FACTOR_A: This macro holds the scaling factor for current at phase 1, this can be set to a value that is in fairly acceptable range and will be fine tuned during calibration.

36. DEFAULT_I_RMS_SCALE_FACTOR_B: This macro holds the scaling factor for current at phase 2, this can be set to a value that is in fairly acceptable range and will be fine tuned during calibration.

37. DEFAULT_I_RMS_SCALE_FACTOR_C: This macro holds the scaling factor for current at phase 3, this can be set to a value that is in fairly acceptable range and will be fine tuned during calibration.

38. DEFAULT_P_SCALE_FACTOR_A_LOW: This macro holds the scaling factor for active power at phase 1, this can be set to a value that is in fairly acceptable range and will be fine tuned during calibration.

39. DEFAULT_P_SCALE_FACTOR_B_LOW: This macro holds the scaling factor for active power at phase 2, this can be set to a value that is in fairly acceptable range and will be fine tuned during calibration.

40. DEFAULT_P_SCALE_FACTOR_C_LOW: This macro holds the scaling factor for active power at phase 3, this can be set to a value that is in fairly acceptable range and will be fine tuned during calibration.
41. DEFAULT_I_RMS_SCALE_FACTOR_NEUTRAL: This macro holds the scaling factor for current at neutral, this can be set to a value that is in fairly acceptable range and will be fine tuned during calibration.

42. DEFAULT_P_SCALE_FACTOR_NEUTRAL: This macro holds the scaling factor for active power at neutral, this can be set to a value that is in fairly acceptable range and will be fine tuned during calibration.

43. DEFAULT_BASE_PHASE_A_CORRECTION_LOW: This macro holds the value for phase correction to compensate for the delay coming from the current transformer at phase 1. This can be set to a value that is in fairly acceptable range and will be fine tuned under phase correction during calibration.

44. DEFAULT_BASE_PHASE_B_CORRECTION_LOW: This macro holds the value for phase correction to compensate for the delay coming from the current transformer at phase 2. This can be set to a value that is in fairly acceptable range and will be fine tuned under phase correction during calibration.

45. DEFAULT_BASE_PHASE_C_CORRECTION_LOW: This macro holds the value for phase correction to compensate for the delay coming from the current transformer at phase 3. This can be set to a value that is in fairly acceptable range and will be fine tuned under phase correction during calibration.

5 Energy meter demo

The energy meter evaluation module (EVM) associated with this application note has the MSP430F47197 and demonstrates up to three phase of energy measurements. The complete demonstration platform consists of the EVM that can be easily hooked to any test system, metrology SW and a PC GUI, which will be used to view results and perform calibration. In this section we will discuss all of these in detail.

5.1 Hardware platform

The EVM consists of two boards, one which is the power supply board and the other which the metrology board. A 10-pin connector interfaces the two boards. The power supply board has been separated from the metrology board for ease of use and also to provide better immunity to ESD and EFT.

5.1.1 EVM overview

The following figures of the EVM best describe the HW. Figure 1 is the top view of the energy meter. The enclosure helps for easy evaluation of the energy meter. The enclosure encapsulates the two boards and on-board current sensors which are CTs.
The top of the EVM shows a 160 segment LCD that displays energy, voltage, current, RTC etc. for all three phases. There is a RS-232 connector available to interface to a PC. Also there is a provision for JTAG to program the MSP430, connector for the Chipcon transceivers and onboard switches for display control.

Figure 14 shows the front view of the EVM with connections that need to be made to the current outputs from the test system. Starting from the right going left connections for current is made. GND on the extreme right can also be connected from the top with the voltages as shown in Figure 15.
Figure 14: Front view with current connections

Figure 15: Top view with voltage connections
5.1.2 Power supply options

The EVM can be configured to operate with different sources for power. The various sources of power to the MSP430 are JTAG, mains voltage, backup-battery.

<table>
<thead>
<tr>
<th>Power option</th>
<th>Header JP1</th>
<th>Header JP2</th>
<th>Header JP7</th>
</tr>
</thead>
<tbody>
<tr>
<td>JTAG</td>
<td>Jumper on [1-2]</td>
<td>No jumper</td>
<td>No jumper</td>
</tr>
<tr>
<td>Mains supply</td>
<td>Jumper on [2-3]</td>
<td>Jumper present</td>
<td>No jumper</td>
</tr>
</tbody>
</table>

Table 1: Power supply selection for MSP430

Table 1 lists the settings on headers JP1, JP2 and JP3 for different options as a source to power the MSP430. By default if no jumper is present on JP1, the MSP430 will still be powered off the mains supply. However, it is important to note that during JTAG programming, a jumper must be present on JP1 [2-3] to indicate external voltage is supplied to the MSP430 and align all JTAG lines out of the USB-FET to this voltage level.

When powered by the mains supply JP2 header can also be treated as a current consumption header by placing an ammeter across. Also, when powered via JTAG, the current consumption header will no longer JP2, instead the ammeter can be connected across [1-2] of header JP1.

5.2 Loading the example code

The source code is developed in the IAR environment using IAR compiler version 4.11. If earlier versions of IAR are used, the project files will not open. If later than 4.11 versions are used when project is loaded, a prompt to create a back-up will be issued and the user can click YES to proceed. There are two parts to the energy metrology software, the tool kit which contains a library of mostly mathematics routines and the main code which has the source and include files. The entire source code is available as zip file attachment with this application note. After the zip is decompressed, two folders will be shown, one for source and the other folder that has the calibration GUI.

5.2.1 Opening the project

The “source” folder structure is shown below

<table>
<thead>
<tr>
<th>Source</th>
</tr>
</thead>
<tbody>
<tr>
<td>Name</td>
</tr>
<tr>
<td>emeter-ng</td>
</tr>
<tr>
<td>emeter-toolkit</td>
</tr>
</tbody>
</table>

The folder “emeter-ng” contains project files for various MSP430 devices and for this application “emeter-47197.ewp” project file is to be used. The folder “emeter-toolkit” has corresponding project file “emeter-toolkit-47197.ewp”. For first time use, it is recommended that both the projects be completely rebuild.
Open IAR window, find and load the project “emeter-toolkit-47197.ewp” and do a rebuild all. Then close the existing workspace and open the main project “emeter-47197.ewp”, rebuild all and load this on to the MSP430F47197 energy meter. This is shown in the snapshot below.

![Figure 16: Project build in IAR](image)

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Once the main project has be rebuilt, load it on to the EVM and hit GO from the Debug menu. Use appropriate jumper settings at Jumper JP1, a jumper placed at pins [1-2] will power the MSP430 from the USB-FET and jumper placed between [2-3] will power the MSP430 with external power. The external power can be from the mains and this is controlled.

6 Results and Calibration

If the procedures and configurations are complete in the previous two sections, the results can be observed and based on these, calibration can be performed. Calibration is key to any meter’s performance and is absolutely necessary for every meter to go through this process. Initially every meter would exhibit different accuracies due to silicon-silicon differences, sensor accuracies and other passive tolerances. In order to nullify their effects, every meter should be calibrated. In this section we will show simple procedures in order to accomplish this process. For any calibration to be performed accurately, there should be an accurate source available. The source should be able to generate any desired voltage, current and phase shifts (between V and I) or power factors. In addition to an accurate source, there should also be a reference meter that will act as an arbitrator between the source and the meter being calibrated. In this section we discuss a simple and effective method of calibration of this 3-phase EVM.

A PC GUI is part of the downloadable zip file with this application note. After decompressing the zip file, a folder by the name “GUI” will have all the necessary files to run this application.

6.1 Viewing results

Once the meter is turned ON, the results can be easily viewed using this GUI by connecting the RS-232 header to the PC. Open the executable “calibrator.exe” in the GUI folder.
Under correct connections the user should see the GREEN filled button under “Comms”. If there problems with connections or if the code is not configured correctly the button will have the color RED.

Click on the green button and we will see the meter results immediately on the GUI. A sample of this is shown below

The configuration of the meter can also be viewed by clicking on “Meter features” to get this screen

Results can also be viewed as pulses fed back to any energy meter test setup. Energy pulses for total active and total reactive energies are available at JP8 (ACT) and JP9 (REACT). In addition, the pulses go through on-board opto-couplers that might be necessary for interface to any test equipment.
6.2 Calibrating the meter

The meter can be calibrated for each phase or total three phases easily using the GUI. Usually gain correction for voltage and current can be done simultaneously for all 3-phases and gain correction for active power must be done individually. Phase correction follows gain correction and this must also be done for each phase individually.

6.2.1 Gain correction

Gain correction for voltage and current can be done simultaneously and the procedure is discussed below

1. Connect GUI to view results for all 3-phases
2. Click on Manual cal seen in the above screen shot to give you this screen

3. The values that need to be entered are in % and this value is calculated by the following formula. For example for any particular voltage the value will be

\[
\%_{\text{VAL}} = \left( \frac{V_{\text{Observed}}}{V_{\text{desired}}} - 1 \right) \times 100
\]

4. Negative values are accepted in the voltage and current fields and the same procedure is applicable for other voltages and currents. For voltages enter in field “Voltage” and for currents, enter in field Current (low). After these values are entered, click on Update meter.

5. Gain correction for active power is done differently; the accuracy obtained from any test system when pulses are fed from the meter is the most accurate method. When calibrating Phase A, disable currents for Phase B and Phase B and have only their voltages ON.

6. Measure accuracy in the reference meter of the test system. This gives the true accuracy of the meter for Phase A active energy.
7. Enter the “% accuracy” seen as-is in the Active (low) field. Click on update meter to do a gain correction on Phase A. Repeat this for all three phases individually disabling currents for the remaining two phases.

6.2.2 Phase correction

Phase correction has to be done on each phase individually and the following is the procedure.

1. Individually for Phase A, set voltage and current with a phase shift of +60 Degrees.

2. See % error on the test setup. If errors are not acceptable, start to enter values for the Phase (low) field. Only increments/decrements should be entered in this field and preferably start with 1 or -1 to determine the direction of correction. Click “Update meter”.

3. Measure error again to see if error increased/decreased. If error decreased, continue to add desired increments till you arrive at an error close to zero, else add decrements.

4. Click on “Update meter” every time a modification is made to this field.

5. Change the phase now to -60 Degrees and check if this error is still acceptable. If not, fine tune the values of Phase (low) again. Ideally, errors should be symmetric for same phase shift on lag and lead conditions.

6. Repeat procedures 1 to 4 for phase B and C individually.

Once the meter has been calibrated it is possible to see these calibrated values for reference. Click on “Meter calibration factors” to get this screen (sample values only).
Implementation of a Three-Phase Electronic Watt-Hour Meter Using the MSP430F471xx
8 Results

Figure 17 shows the results of the energy meter EVM.

![Figure 17: Active power results](image)

Highlights of the results:

1. Less than 0.1% accuracy for unity PF at room temperature for a dynamic range of 2400:1
2. Less than 0.03% accuracy for unity PF at room temperature for a dynamic range of 1200:1
3. Overall accuracy of 0.3% for phase lag and lead at room temperature for a dynamic range of 2400:1
4. Overall accuracy of 0.2% for phase lag and lead at room temperature for a dynamic range of 1200:1

Implementation of a Three-Phase Electronic Watt-Hour Meter Using the MSP430F471xx
9 Reference

1 IEC62053 electricity meter specification
2 GB/T 17883-1999 electricity meter specification
3 MSP430F471x6, F471x7 data sheets
4 MSP430x4xx Family User’s Guide SLAU056
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